

# **MXE-210 Series**

# Intel Atom® Processor E3900 Family-Based Ultra Compact Embedded Platform

#### **Features**

- Equipped with Intel Atom® x7-E3950/x5-E3930 processors
- Compact fanless design: 140(W) x 110(D) x 58(H) mm
- Rich I/O & expansion:
  - 1x DisplayPort, 2x USB 2.0, 2x USB 3.0, 2x GbE ports, 2x COM ports (RS-232/422/485)
  - 2x mPCle slots, 1x USIM slot, 1 x mSATA, 1x Micro SD slot
- Optional
  - 1 x 2.5 " SATA SSD by storage kit or isolated 8x DI/ 8x DO
- eSIM support (by project)
- Built-in ADLINK SEMA management solution
- Railway EN50121 compliance























ADLINK's new Matrix MXE-210 series of ultra compact embedded platforms, based on the Intel Atom® x5-E3930/x7-E3950 Processor, delivers optimum I/O design for maximum connectivity.

With two GbE LAN ports, two COM ports, two USB 2.0 and two USB 3.0 host ports, and dual mPCIe slots and USIM socket support communication with connections via Wi-Fi, BT, 3G, LoRa(SX1276), and 4G LTE, the MXE-210 series enables seamless interconnection, ensuring interoperability between systems. Matrix's proven rugged construction assures operation in harsh environments with operating shock tolerance up to 100 G and extended operating temperatures of -40°C to 85°C(\*) available.

The MXE-210 series presents an intelligent, robust embedded system supporting wide application development and easy service deployment, for outstanding performance in Intelligent Transportation, Facility Management, Industrial Automation, and Internet of Things (IoT) applications.

### **Software Support**

- Windows<sup>®</sup> 10 IoT Enterprise 64Bit
- Ubuntu Linux 16.04 LTS 64Bit
- Wind River® Pulsar™ Linux LTS 17 (Support by request)
- Debian 8.5 64Bit

# Ordering Information

MXE-211/M2G Intel Atom® x7-E3950, 2GB RAM

MXE-212/M2G Intel Atom® x5-E3930, 2GB RAM

MXE-211-ET/M2G Intel Atom® x7-E3950, 2GB ET RAM, -20-70°C

MXE-212-ET/M2G Intel Atom® x5-E3930, 2GB ET RAM, -20-70°C

 MXE-212-WT/M2G/ETT Intel Atom® x5-E3930, 2GB WT RAM, ETTS -40-85°C performed

MXE-211-S/M2G | MXE-212-S/M2G Intel Atom® x7-E3950/x5-E3930, 2GB RAM, 2.5" SATA kit



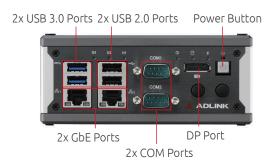
DIN Rail support



Wall Mounting support (Optional)

# Optional Accessories

- mSATA/ Micro SD
- 2.5" SATA HDD/SSD Kit (P/N: 91-95223-0010) Extend 1x 2.5" SATA via a cable and a bracket inside MXE-210
- Wireless Kit WiFi/BT/3G/4G LTE/LoRa wireless kit (w/ Antenna)
- 40/90W AC Adapter 40W ind. grade AC-DC adapter 90W ind. grade AC-DC adapter (when 2x mPCIe w/ full loading)
- Wall mount kit (P/N: 91-95221-0010)





System Core Processor In Base Freq. Burst Freq.	tel Atom <sup>®</sup> x7-E3950 (quad-core) 1.6 GHz 2.0 GHz	Intel Atom® x5-E3930 (dual-core) 1.3 GHz
Base Freq.	1.6 GHz	
Base Freq.	1.6 GHz	1 3 CH <sub>7</sub>
Rurch Fron	2 0 GHz	1.5 0112
		1.8 GHz
Video	1x DisplayPort 1.2 (Support DP++)	
Memory	1x DDR3L 1600MHz SODIMM 2 GB (up to 8GB)	
I/O Interface		
Ethernet	2x Intel® I210IT	
Serial Port	2x RS-232/422/485	
DI/O	1.5kV isolated 8x DI + 8x DO (Optional, shared location w/ 2.5" SATA)	
USB	2x USB 2.0 + 2x USB 3.0	
Audio	Mic-in, Line-out (Optional)	
Expansion		
Mini PCle	2 x full-size	
USIM	1 (by request)	
eSIM	i (by request)	
Manageability	Watch Dog Timer support by SEMA	
WDT	SEMA 3.5 support with BMC	
SEMA	SEINA 3.3 SUPPOIL WILLI DIVIC	
Power Supply		
DC Input	6-36 V <sub>DC</sub>	
AC Input	Optional 40/90W AC-DC adaptor	
Storage Device		
mSATA	1x full-size	
2.5" SATA	1 (only for MXE-210-S)	
Micro SD	1	
Mechanical		
Dimensions	140 (W) x 110 (D) x 58 (H) mm (5.5" x 4.3" x 2.3")	
Weight	0.95 Kg (2.06 lbs)	
Mounting	DIN rail (optional: wall mount)	
Other		
Device-Level Security	TPM2.0, Intel Boot Guard, UEFI Secure Boot	
Environmental		
• Standard: 0°C	to 50°C (32°F to 122°F) °C to 70°C (-4°F to 158°F) w/ ind. SSD	<ul> <li>Standard: 0°C to 50°C (32°F to 122°F)</li> <li>Extended: -20°C to 70°C (-4°F to 158°F) w/ ind. SSD</li> <li>Wide: -40°C to 85°C (-40°F to 185°F) w/ ind. SSD and ETTS performed, RF/Function mPCIe are excluded</li> </ul>
Storage Temperature	-40°C to 85°C (-40°F to 185°F)	
Humidity	approx. 95% @ 40°C (Non-condensing)	
Vibration	Operating: 5 Grms, 5-500 Hz, 3 axes w/ SSD	
ESD	Contact +/-4 KV, Air +/-8 KV	
Shock	Operating: 100 G, half sine 11 ms duration w/ SSD	
EMC	CE and FCC Class B (EN61000-6-4/-2), compliance with EN50121	
Safety	UL, CB, CCC	

